

## FLIP CHIP MODULES TEST SPECS

TYPE:

M117

6 - 4 INPUTS NAND GATES

TEST	CONDITIONS	MAX I MUM	MINIMUM
Vout	$V_{CC} = +4.75 \text{ V}$ $V_{IN} = +2.0 \text{ V}$ $I_{LOAD} = -16 \text{ MA}$	+0.4 V	
V <sub>OUT</sub>	$V_{CC} = +4.75 \text{ V}$ $V_{IN} = +0.8 \text{ V}$ $I_{LOAD} = +400  \mu\text{A}$		+2.4 V
IIN	V <sub>CC</sub> = +5.25 V MEASURED TO +0.4 V	-1.6 MA	
IIN	V <sub>CC</sub> = +5.25 V MEASURED TO +2.4 V	+40 µA	
TD <sub>1</sub>	V <sub>CC</sub> = +5.00 V ONE(RISE) DELAY 50% TO 50%	30 NS	
TD <sub>O</sub>	V <sub>CC</sub> = +5.00 V ZERO (FALL)DELAY 50% TO 50%	15 NS	
v <sub>s</sub>	V <sub>CC</sub> = +5.00 V OPEN CIRCUIT VOLTAGE	+4.0 V	+3.0 V
	VCC = +5,00 V SHORT CIRCUIT CURRENT TO GND	-17.0 MA	-13.0 MA

## TECHNICAL INFORMATION

9/27/67